

TN2301PSA

P-Channel Enhancement Mode Power MOSFET SOT-23

Product Summary

- $V_{DS} = -20V, I_D = -2.3A$
- $R_{DS(on)} < 110m\Omega @ V_{GS} = -4.5V$
- $R_{DS(on)} < 140m\Omega @ V_{GS} = -2.5V$

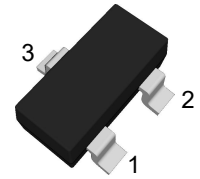
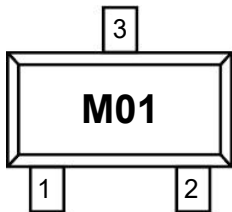
Features

- ⌘ TrenchFET Power MOSFET

Application

- ⌘ Load Switch for Portable Devices
- ⌘ DC/DC Converter

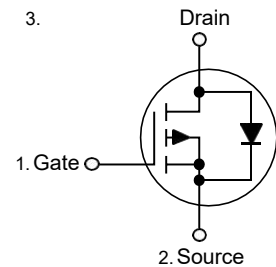
Marking Code



(Top View)

Pin	Description
1	Gate
2	Source
3	Drain

Schematic Diagram



Absolute Maximum Ratings

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	
Continuous Drain Current ($T_J = 150^\circ C$)	I_D	-2.3	A
Pulsed Drain Current	I_{DM}	-1	
Continuous Source-Drain Diode Current	I_S	-0.72	
Maximum Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient($t \leq 5s$)	$R_{\theta JA}$	357	$^\circ C/W$
Operation Junction and Storage Temperature Range	T_J, T_{stg}	-5 ~+150	$^\circ C$

Electrical Characteristics

(Ta=25°C unless otherwise specified)

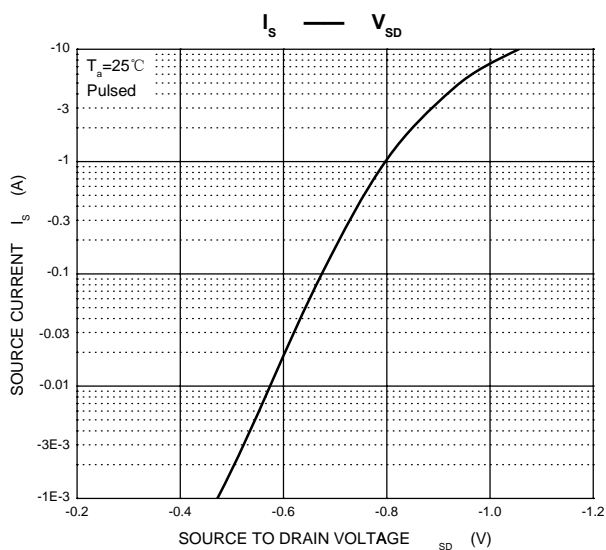
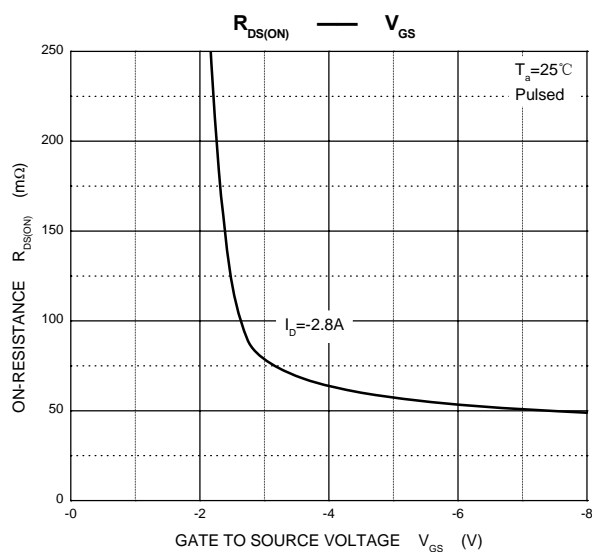
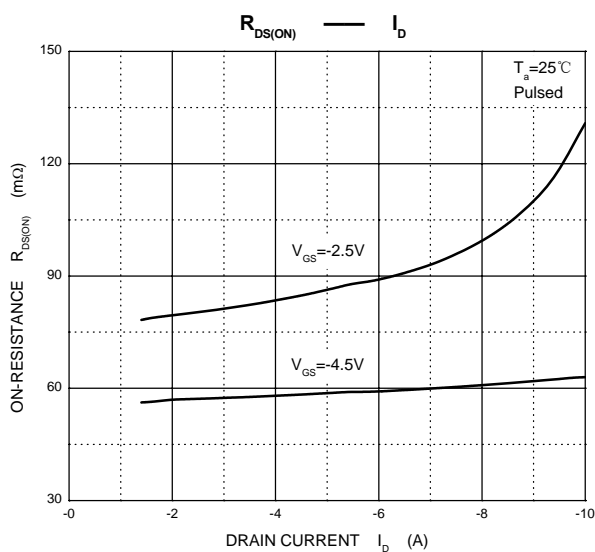
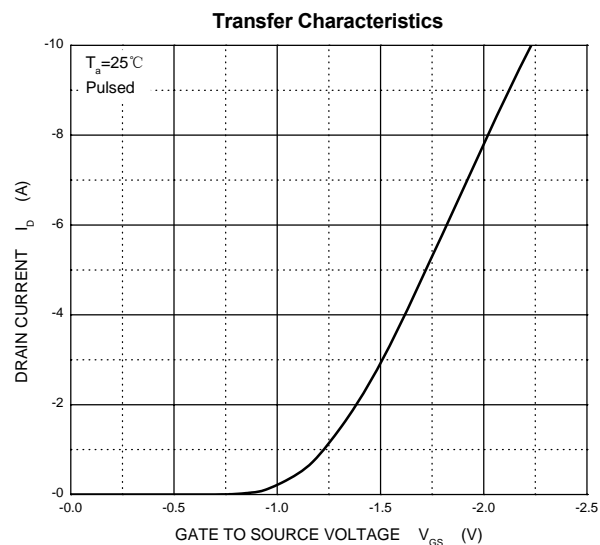
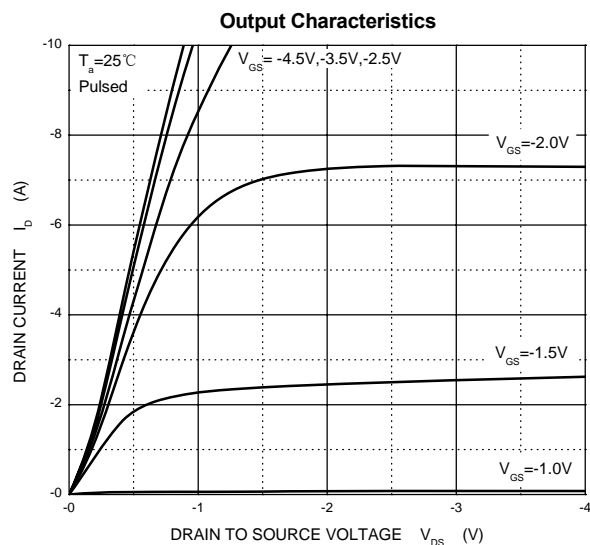
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =-250μA	-2			V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.	-0.65	-	
Gate-source leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V			-	μA
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} =-4.5V, I _D =-2.3A		102	110	mΩ
		V _{GS} =-2.5V, I _D =-2.0A		126	140	
Forward transconductance ^a	g _{fs}	V _{DS} =-5V, I _D =-2.3A		4.0		S
Dynamic ^b						
Input capacitance	C _{iss}	V _{DS} =-10V,V _{GS} =0V,f =1MHz		405		pF
Output capacitance	C _{oss}			75		
Reverse transfer capacitance	C _{rss}			55		
Total gate charge	Q _g	V _{DS} =-10V,V _{GS} =-4.5V,I _D =-2.3A		5.5	10	nC
		V _{DS} =-10V,V _{GS} =-2.5V,I _D =-2.3A		3.3	6	
Gate-source charge	Q _{gs}			0.7		
Gate-drain charge	Q _{gd}			1.3		
Gate resistance	R _g	f =1MHz		6.0		Ω
Turn-on delay time	t _{d(on)}	V _{DD} =-10V, R _L =10Ω, I _D =-1A, V _{GEN} =-4.5V,R _g =1Ω		11	20	ns
Rise time	t _r			35	60	
Turn-off delay time	t _{d(off)}			30	50	
Fall time	t _f			10	20	
Drain-source body diode characteristics						
Continuous source-drain diode current	I _S	T _C =25°C			-1.	A
Pulse diode forward current ^a	I _{SM}				-1	
Body diode voltage	V _{SD}	I _S =-0.7A		-0.	-1.	V

Notes :

a.Pulse Test : Pulse Width < 300 μs , Duty Cycle $\leq 2\%$.

b.Guaranteed by design, not subject to production testing.

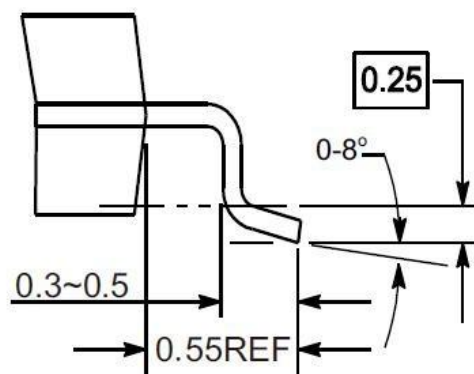
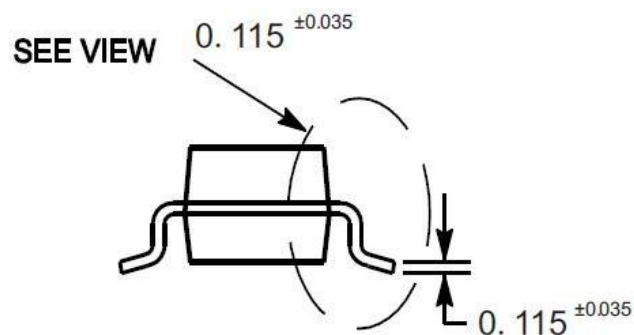
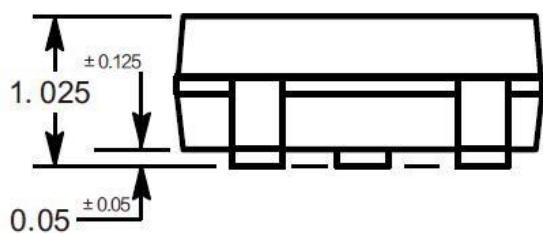
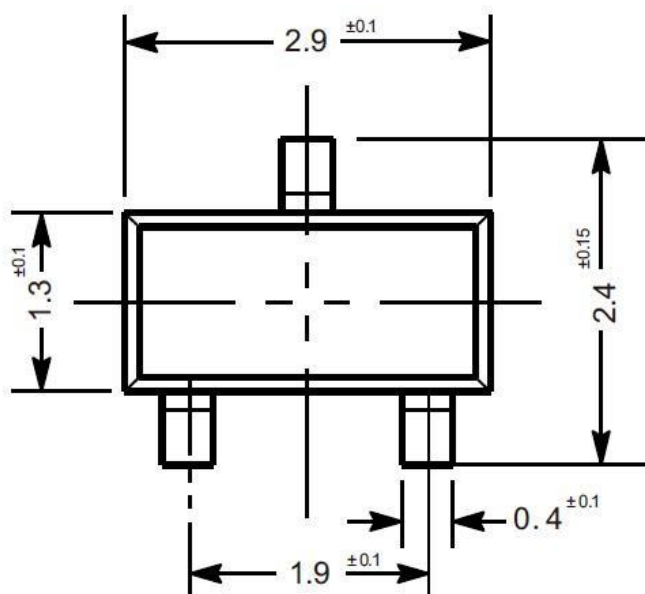
Typical Characteristic Curves



Package Outline

SOT-23

Dimensions in mm



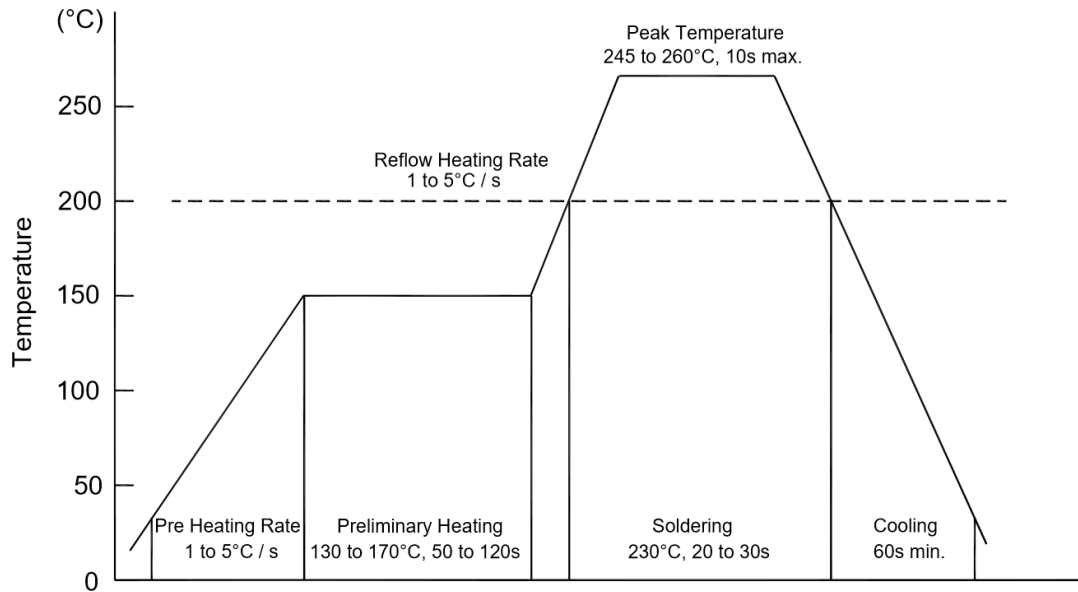
VIEW C

Ordering Information

Device	Package	Shipping
TN2301PSA	SOT-23	3,000PCS/Reel&7inches

Conditions of Soldering and Storage

◆ Recommended condition of reflow soldering



Recommended peak temperature is over 245°C. If peak temperature is below 245°C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

◆ Conditions of hand soldering

- Temperature: 300°C
- Time: 3s max.
- Times: one time

◆ Storage conditions

● Temperature

5 to 40°C

● Humidity

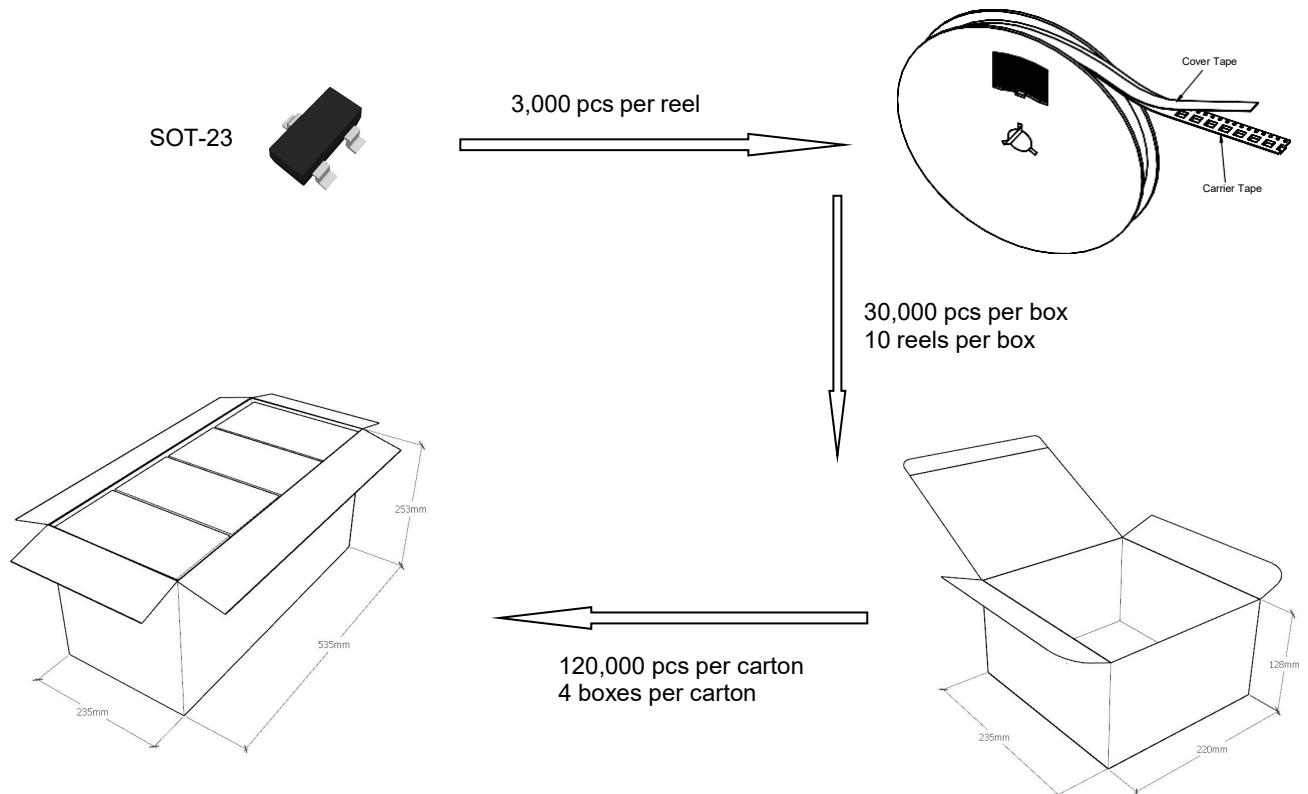
30 to 80% RH

● Recommended period

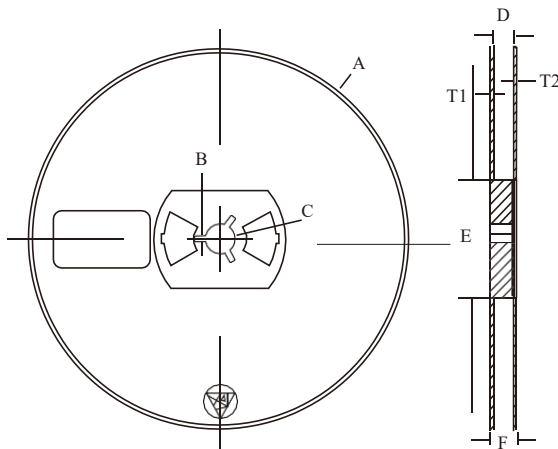
One year after manufacturing

Package Specifications

- The method of packaging

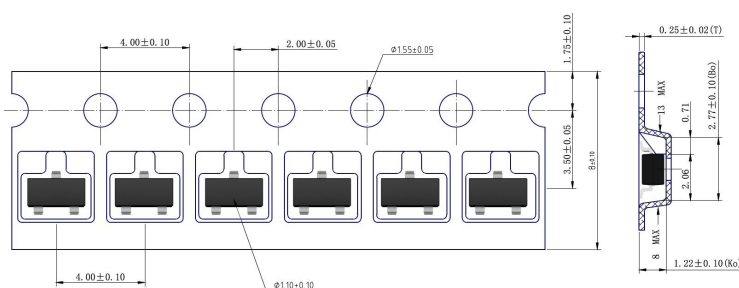


◆ Embossed tape and reel data



Reel (7")


Symbol	Value (unit: mm)
A	$\varnothing 177.8 \pm 1$
B	2.7 ± 0.2
C	$\varnothing 13.5 \pm 0.2$
E	$\varnothing 54.5 \pm 0.2$
F	12.3 ± 0.3
D	$9.6 +2/-0.3$
T1	1.0 ± 0.2
T2	1.2 ± 0.2



Contact Information

TANI website: <http://www.tanisemi.com> Email: tani@tanisemi.com

For additional information, please contact your local Sales Representative.

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The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up-to-date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

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